These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

**Assembly Note:****

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
Place Block Diagram here (if appropriate) or delete this text box. If using a block diagram from another tool, save the picture as a .bmp file. Then, use menu Place|Drawing Tools|Graphic to insert the .bmp file on the schematic.
Input Voltage = 300Vin to 600Vin (DC)
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